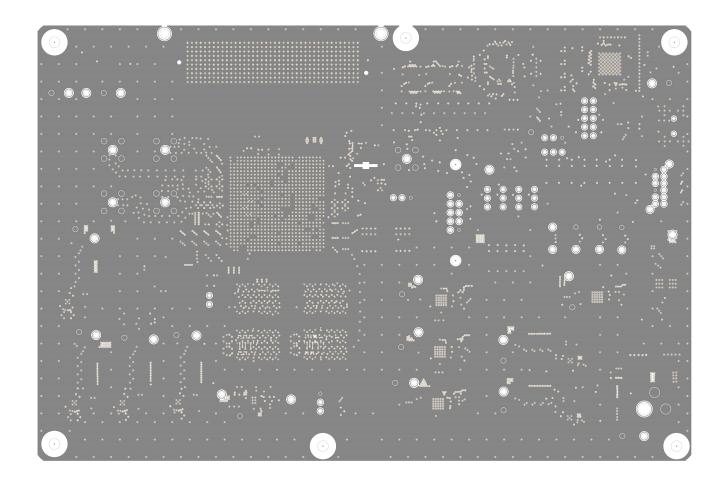
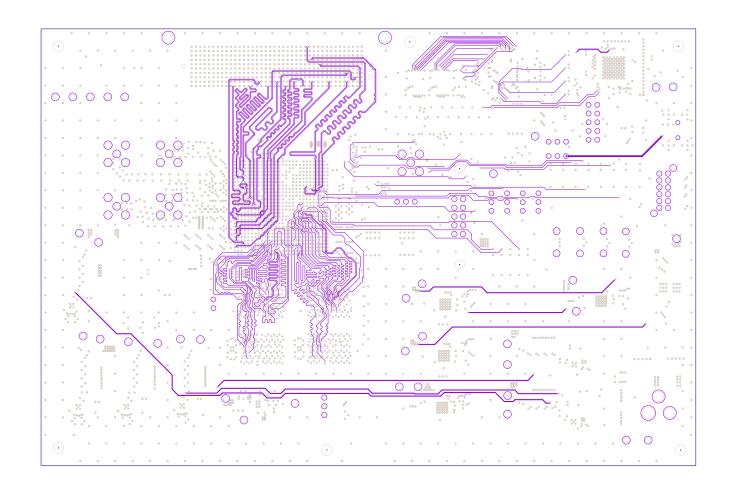
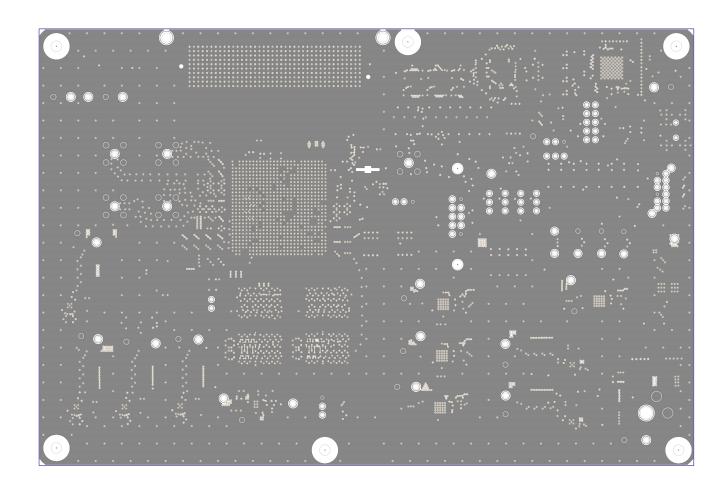


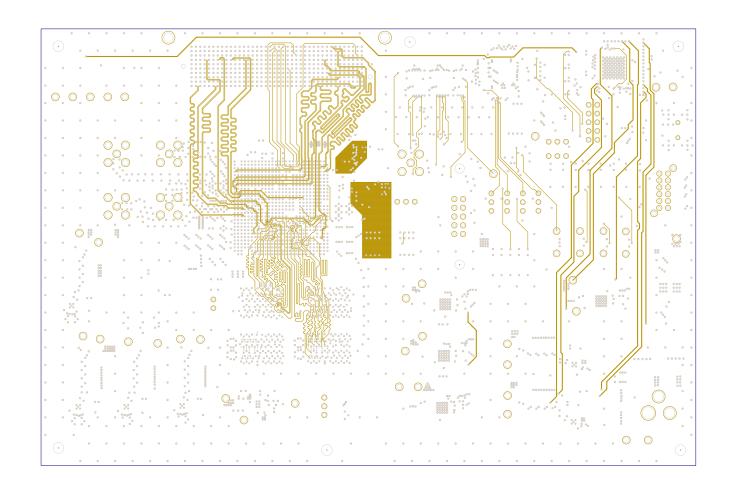
TEXAS INSTRUMENTS TSW14J56EVM REV B SILKSCREENTOPSIDE)



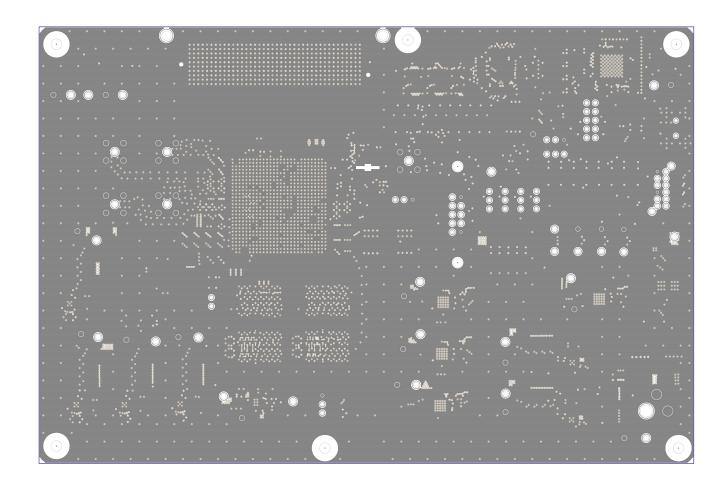


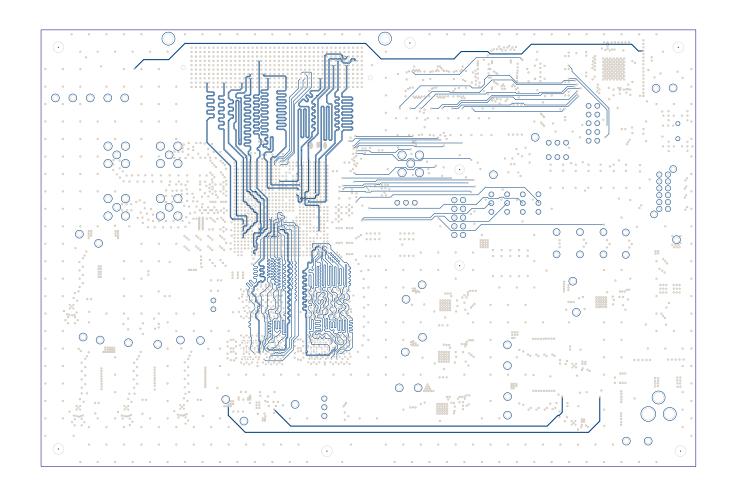
TEXAS INSTRUMENTS TSW14J56EVM REV B LAYER 3 (SIG1)



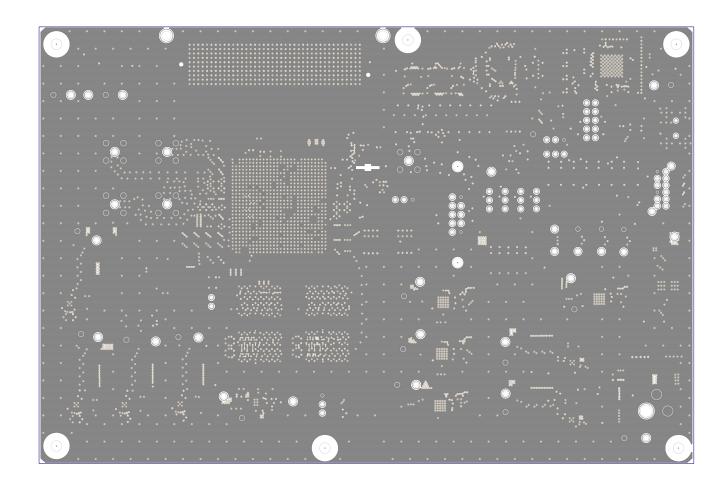


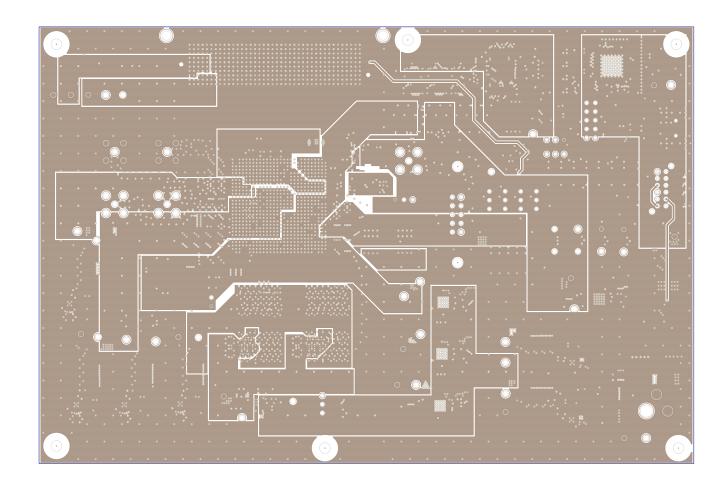
TEXAS INSTRUMENTS TSW14J56EVM REV B LAYER 5 (SIG2)

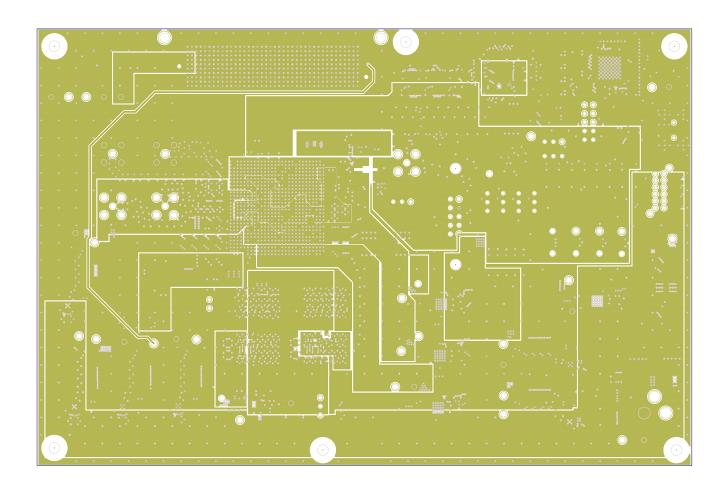


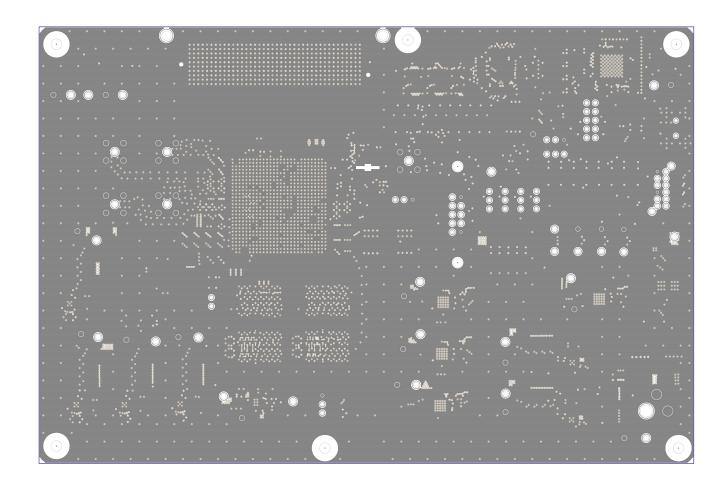


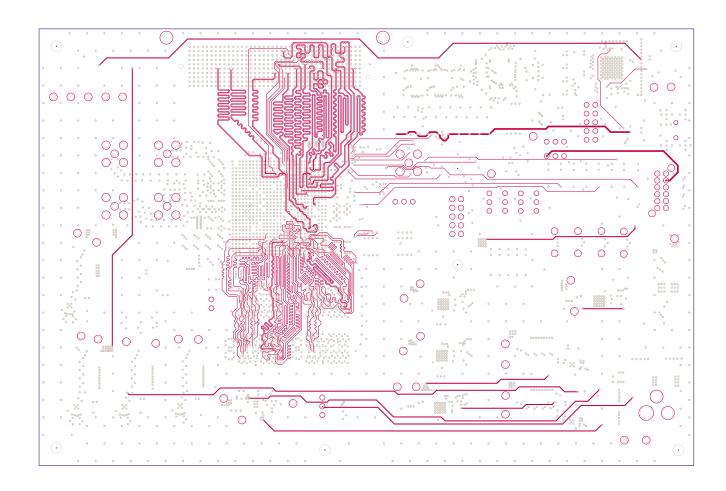
TEXAS INSTRUMENTS TSW14J56EVM REV B LAYER 7 (SIG3)



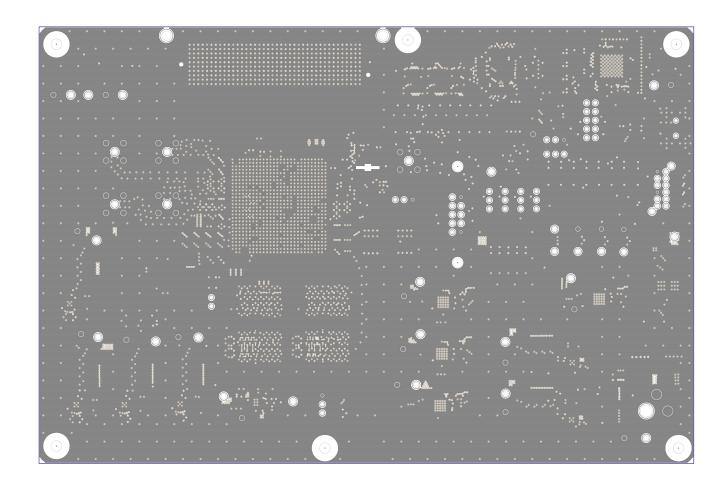


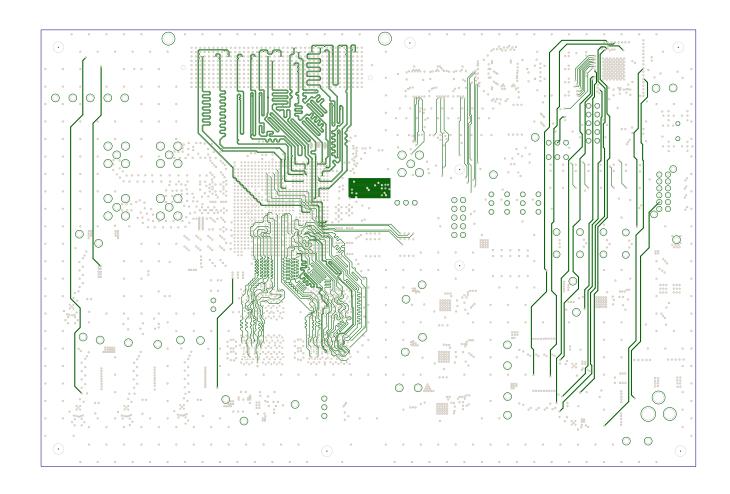


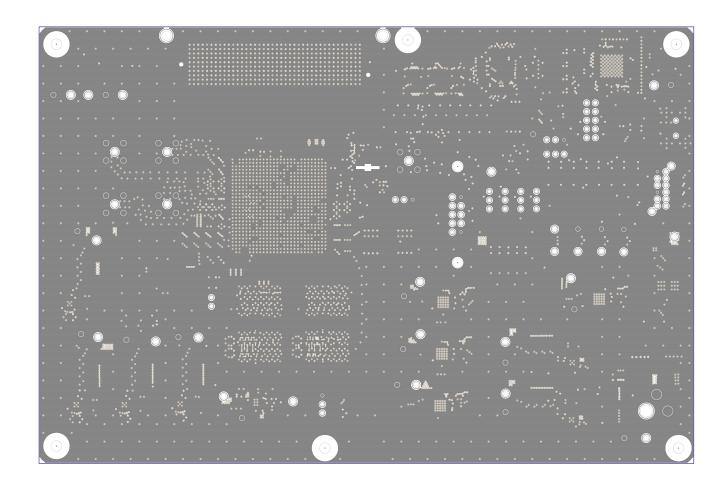


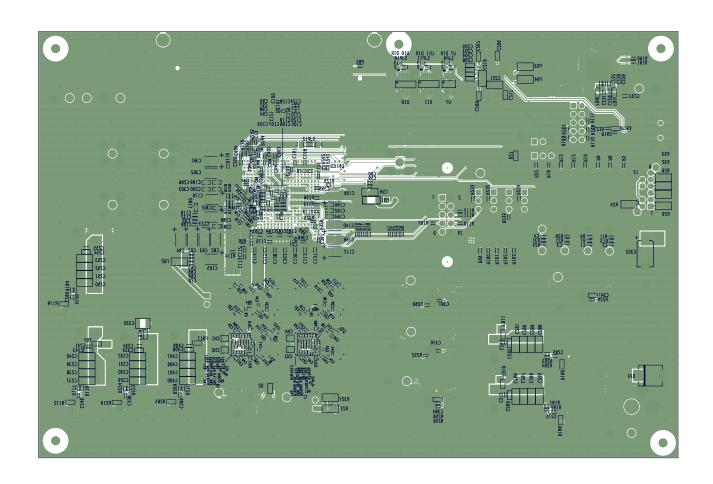


TEXAS INSTRUMENTS TSW14J56EVM REV B LAYER 12 (SIG4)

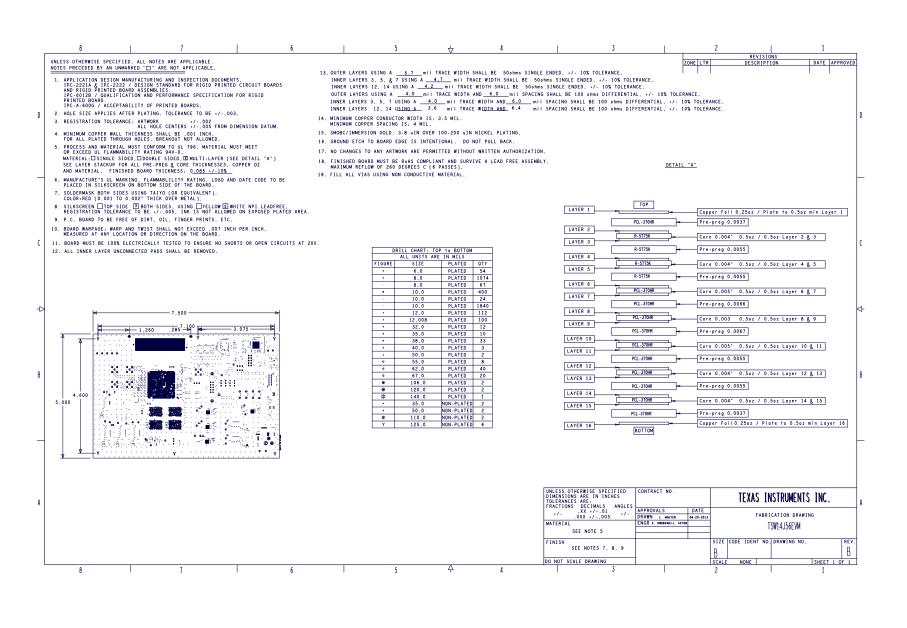








TEXAS INSTRUMENTS TSW14J56EVM REV B \$14K\$CREENBBOTTOMSIDE)



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